

YGF294N75 Grounding Plate, #2 AWG-250 kcmil Cu, 4-Hole, 1/2" Stud, 1-3/4" Spacing

By Burndy Catalog # YGF294N75



General

Die Index	997
Material	Copper
Physical Attribute - Number of Crimps Required	2
Physical Attribute - Number of Tapped Holes	4
Plated	Ν
Plating Type	Unplated
Trade Name	HYGROUND [®]
UPC	781810144411
UPC 12 Digit	7818101444111

Dimensions

Dimension - D inch	3.25 in
Dimension - F Width Center to Center inch	1.75 in
Dimension - Height fraction	3-31/50 in
Dimension - Height inch	3.62 in
Dimension - L Length Overall mm	147 mm
Dimension - Length Overall inch	5.78 in
Dimension - Pad Width inch	3.25 in
Dimension - Thread Size	3/4-10, 0.81 EFF Thread
Physical Attribute - Tongue Angle	Straight



Conductor Related

Conductor - Copper Str Size	2 AWG;1 AWG;1/0 ;2/0 AWG;3/0 AWG;4/0 AWG;250 kcmil	
Conductor - Copper Str Size Range	2 AWG-250 kcmil	
Conductor Type	CU C Str-Size	
Certifications And Compliance		
Certification - CSA Approved	No	

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Certification - CSA Approved	No
Certification - ETL	No
Certification - UL Listed Direct Burial	Yes
Certification - UL Recognized	No
Certification - cULus	No
Industry Standard(s)	NEMA Size Holes
Standards - Industry Standards Met	UL467;IEEE 837
Standards - RoHS Compliance Status	UI
UL Listed	No

Logistics

Minimum Pack Quantity

Product Assets

3D Models - YGF294N75_MODEL-IGES 3D Models - YGF294N75_MODEL-STEP 3D Models - YGF294N75_MODEL-PDF Catalogs - Full Line BURNDY Catalog